

AMENDMENTS TO THE CLAIMS:

Please amend Claims 1-3, 7, 13, 14, and 18 as follows. In accordance with the revised amendment format, all claims are presented below.

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1. (Currently Amended) A circuit connection structure, comprising:  
a first substrate forming having a part of a display panel and an  
  
having electrode terminals terminal formed thereon;  
a circuit board disposed with a space between said circuit board and  
said substrate and having thereon an electrode terminal;  
a semiconductor device comprising a driver IC, said semiconductor  
device having a first electrodes electrode and a second electrodes electrode; and with the  
first electrodes connected to the electrode terminals of the first substrate,  
a flexible wiring member having disposed in a lateral position with  
respect to the first substrate having thereon a pattern of conductors each extending from a  
first conductor end to a second conductor end on the flexible wiring member with the first  
conductor ends of the conductors a conductor, wherein opposite ends of the conductor of  
said flexible wiring member are connected to the second electrodes of the semiconductor  
device, and a circuit board disposed with a space from the first substrate and having  
thereon electrode terminals connected to the second conductor ends of the conductors on  
the flexible wiring member electrode and the electrode terminal of said circuit board,  
respectively, and

wherein said semiconductor device bridges the space between the first substrate and the circuit board, and such that the driver IC is located over the space  
and the first electrode of the semiconductor device is connected the second conductor ends of the conductors on the flexible wiring member are connected to the electrode terminals of the circuit board, and the first electrodes of the semiconductor device are connected to the electrode terminals of terminal on the first substrate, respectively, with an anisotropic conductive adhesive.

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2. (Currently Amended) A connection structure according to Claim 1, wherein in said semiconductor device the first and second electrodes are structured to act as output and input electrodes, respectively, thereof so as to receive input data from the circuit board and supply output signals to the first substrate, thereby driving an electronic device including the first substrate.

3. (Currently Amended) A connection structure according to Claim 1, wherein the second electrodes electrode of the semiconductor device are is connected to the first conductor ends of the conductors conductor on the flexible wiring member by a tape-automated bonding method.

4-6 (Cancelled)

7. (Currently Amended) A connection structure according to Claim 1,  
wherein a connecting part the connection between the second electrodes electrode of the  
semiconductor device and the first conductor ends of the conductors conductor on the  
flexible wiring member is sealed with a resin.

8. (Withdrawn)

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9. (Withdrawn)

10-12 (Cancelled)

13. (Currently Amended) A display apparatus, comprising:  
a display panel comprising at least one substrate, said at least one  
substrate having thereon a pixel electrodes electrode extending to form an electrode  
terminals terminal on a peripheral side of the said at least one substrate;,  
a semiconductor device having an input electrodes electrode, and an  
output electrodes electrode for supplying drive waveforms to the pixel electrodes electrode  
of the display panel; and  
a circuit board disposed with a space from the display panel between  
said circuit board and said at least one substrate of the display panel and having an  
electrode terminals terminal for supplying an electric power and control signals to the  
semiconductor device; wherein

~~the electrode terminals on at least one substrate of the display panel are connected to the output electrodes of the semiconductor device, and~~

wherein the semiconductor device is connected to the circuit board via a flexible wiring member disposed in a lateral position with respect to the said at least one substrate, said flexible wiring member having thereon a pattern of conductors conductor each extending from a first conductor end to a second conductor end so that the input electrodes electrode of the semiconductor device are is connected to the first conductor ends of the conductors on the flexible wiring member end, and the second conductor ends of the conductors of the flexible wiring member are end is connected to the electrode terminals terminal of the circuit board, and

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wherein said semiconductor device bridges the space between said at least one substrate of the display panel and the circuit board, and the second conductor ends of the conductors on the flexible wiring member are connected to the electrode terminals of the circuit board, and such that the driver IC is located over the space and the output electrodes electrode of the semiconductor device are is connected to the electrode terminals terminal on said at least one substrate of the display panel, respectively, with an anisotropic conductive adhesive.

14. (Currently Amended) A display apparatus according to Claim 13, wherein the input electrodes electrode of the semiconductor device are is connected to the first conductor ends end of the conductors conductor on the flexible wiring member by a tape-automated bonding method.

15. (Cancelled)

16. (Withdrawn)

17. (Cancelled)

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18. (Currently Amended) A display apparatus according to Claim 13,  
wherein a ~~connecting part~~ the connection between the second ~~electrodes~~ electrode of the  
semiconductor device and the first conductor ~~ends~~ end of the conductors conductor on the  
flexible wiring member is sealed with a resin.

19-29 (Withdrawn)

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